### 捷多邦,专业PCB打样**\$N54BOT373**出**\$N74BCT373** OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPU

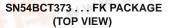
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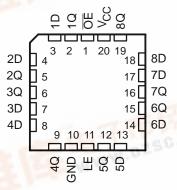
- Operating Voltage Range of 4.5 V to 5.5 V
- State-of-the-Art BiCMOS Design Significantly Reduces I<sub>CCZ</sub>
- Full Parallel Access for Loading

SN54BCT373...J OR W PACKAGE SN74BCT373...DB, DW, N, OR NS PACKAGE (TOP VIEW)

•	,	
1	U 20	Vcc
2		8Q
		BD
4		] 7D
5	16	] 7Q
		] 6Q
_		] 6D
8		] 5D
	12	] 5Q
[] 10	11	LE
	2 3 4 5 6 7 8 9	2 19 3 18 4 17 5 16 6 15 7 14 8 13 9 12

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- **ESD Protection Exceeds JESD 22** 2000-V Human-Body Model (A114-A)





### description/ordering information

These 8-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight latches of the 'BCT373 devices are transparent D-type latches. While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When the latch enable is taken low, the Q outputs are latched at the logic levels that were set up at the D inputs.

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

### ORDERING INFORMATION

TA	PACKA	GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	SN74BCT373N	SN74BCT373N
0°C to 70°C	SOIC - DW	Tube	SN74BCT373DW	BCT373
	30IC - DW	Tape and reel	SN74BCT373DWR	BC1373
	SOP - NS	Tape and reel	SN74BCT373NSR	BCT373
	SSOP - DB	Tape and reel	SN74BCT373DBR	BT373
197	CDIP – J	Tube	SNJ54BCT373J	SNJ54BCT373J
–55°C to 125°C	CFP – W	Tube	SNJ54BCT373W	SNJ54BCT373W
	LCCC – FK	Tube	SNJ54BCT373FK	SNJ54BCT373FK

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

**TEXAS** 

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of



### SN54BCT373, SN74BCT373 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

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### description/ordering information (continued)

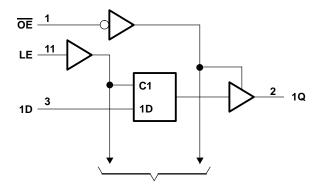
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

## FUNCTION TABLE (each latch)

	INPUTS		OUTPUT
OE	LE	D	Q
L	Н	Н	Н
L	Н	L	L
L	L	Χ	Q <sub>0</sub>
Н	Χ	Χ	Z

### logic diagram (positive logic)



To Seven Other Channels

### SN54BCT373, SN74BCT373 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	0.5 V to 7 V
Voltage range applied to any output in the disabled or power-off state, $V_{\hbox{\scriptsize O}}$	
Voltage range applied to any output in the high state, $V_{\mbox{\scriptsize O}}$	$\dots$ -0.5 V to V <sub>CC</sub>
Input clamp current, I <sub>IK</sub>	–30 mA
Current into any output in the low state: SN54BCT373	96 mA
SN74BCT373	128 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DB package	70°C/W
DW package	
N package	69°C/W
NS package	60°C/W
Storage temperature range, T <sub>stq</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions (see Note 3)

		SN54BCT373		SN74BCT373			UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
lıĸ	Input clamp current			-18			-18	mA
ІОН	High-level output current			-12			-15	mA
loL	Low-level output current			48			64	mA
T <sub>A</sub>	Operating free-air temperature	-55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



### **SN54BCT373**, **SN74BCT373 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS**

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### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER	TEST CONDITIONS		SN	54BCT3	73	SN74BCT373			UNIT
PARAMETER			MIN	TYP†	MAX	MIN	TYP	MAX	UNII
VIK	$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V
		$I_{OH} = -3 \text{ mA}$	2.4	3.3		2.4	3.3		
Voн	V <sub>CC</sub> = 4.5 V	$I_{OH} = -12 \text{ mA}$	2	3.2					V
		$I_{OH} = -15 \text{ mA}$				2	3.1		
Vol	V00 - 45 V	I <sub>OL</sub> = 48 mA		0.38	0.55				V
VOL	V <sub>CC</sub> = 4.5 V	$I_{OL} = 64 \text{ mA}$					0.42	0.55	V
lį	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 5.5 V			0.4			0.4	mA
lіН	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 2.7 V			20			20	μΑ
I <sub>I</sub> L	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0.5 V			-0.6			-0.6	mA
los <sup>‡</sup>	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 0	-100		-225	-100		-225	mA
<sup>I</sup> OZH	$V_{CC} = 5.5 \text{ V},$	$V_0 = 2.7 \text{ V}$			50			50	μΑ
lozL	$V_{CC} = 5.5 \text{ V},$	$V_0 = 0.5 V$			-50			-50	μΑ
ICCL	V <sub>CC</sub> = 5.5 V			37	60		37	60	mA
Іссн	V <sub>CC</sub> = 5.5 V			2	5		2	5	mA
ICCZ	V <sub>CC</sub> = 5.5 V			5	8		5	8	mA
C <sub>i</sub>	V <sub>CC</sub> = 5 V,	V <sub>I</sub> = 2.5 V or 0.5 V		6			6		pF
Co	$V_{CC} = 5 V$ ,	$V_0 = 2.5 \text{ V or } 0.5 \text{ V}$		11			11		pF

# timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

		V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C		$V_{CC} = 5 \text{ V},$ $T_A = 25^{\circ}\text{C}$ SN54BCT373		SN74BCT373		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>W</sub>	Pulse duration, LE high	7.5		7.5		7.5		ns
t <sub>su</sub>	Setup time, data before LE↓	2		2		2		ns
th	Hold time, data after LE↓	5.5		5.5		5.5		ns

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. ‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

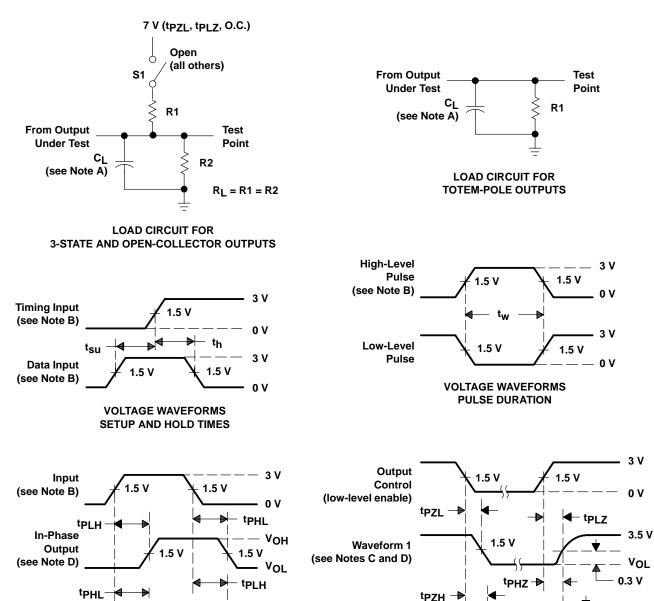
# SN54BCT373, SN74BCT373 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS SCBS016D - SEPTEMBER 1988 - REVISED MARCH 2003

### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C <sub>I</sub> R1 R2 T <sub>A</sub>	CC = 5 V = 50 pl = 500 Q = 500 Q = 25°C	F, Ω, Ω,	C R R	L = 50 p 1 = 500 2 = 500 4 = MIN	Ω,	Ť	UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	2	^	2	5.9	7.7	1.5	10.1	2	9.3	
t <sub>PHL</sub>	D	Q	2	6.7	8.5	1	10.3	1.5	9.5	ns
tPLH	1.5	0	2	6.2	8.2	2	10.1	2	9.3	20
t <sub>PHL</sub>	LE	Q	2	5.9	7.8	2	9.2	2	8.8	ns
<sup>t</sup> PZH	ŌĒ	0	1	7.8	9.6	1	12.3	1	11.8	20
t <sub>PZL</sub>	UE UE	Q	1	8.2	10.2	1	12.5	1	12	ns
t <sub>PHZ</sub>	ŌĒ	Q	1	4.9	6.6	1	7.4	1	7	ns
tPLZ	OE .	ά	1	5	6.7	1	8.1	1	7.4	115

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

### PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES (see Note D)

1.5 V

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

Vон

0.3 V

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

**Out-of-Phase** 

(see Note D)

Output

B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $t_r = t_f \leq 2.5$  ns, duty cycle = 50%.

Waveform 2

(see Notes C and D)

- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.

Vон

VOL

1.5 V

- $\hbox{E.} \ \ \ \hbox{When measuring propagation delay times of 3-state outputs, switch S1 is open.}$
- F. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms





### PACKAGE OPTION ADDENDUM

4-Mar-2005

### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
5962-9074601M2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-9074601MRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
5962-9074601MSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SN74BCT373DBLE	OBSOLETE	SSOP	DB	20		None	Call TI	Call TI
SN74BCT373DBR	ACTIVE	SSOP	DB	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74BCT373DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74BCT373DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74BCT373N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74BCT373NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54BCT373FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54BCT373J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54BCT373W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

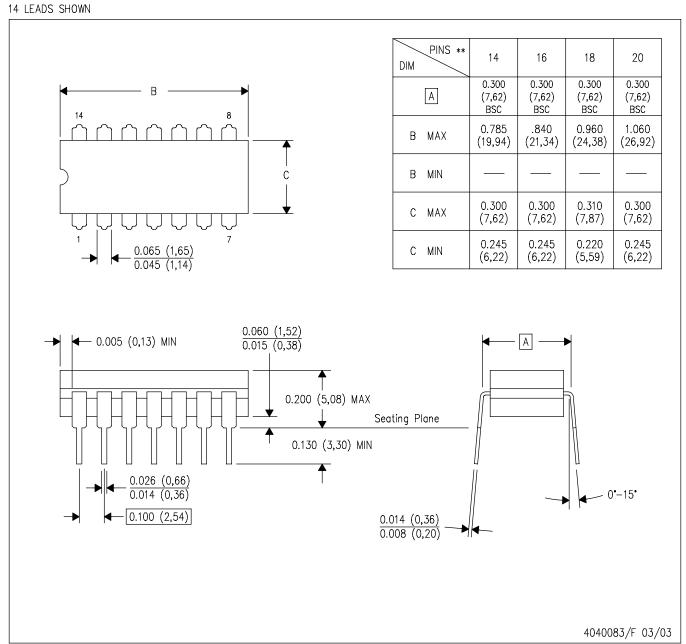
**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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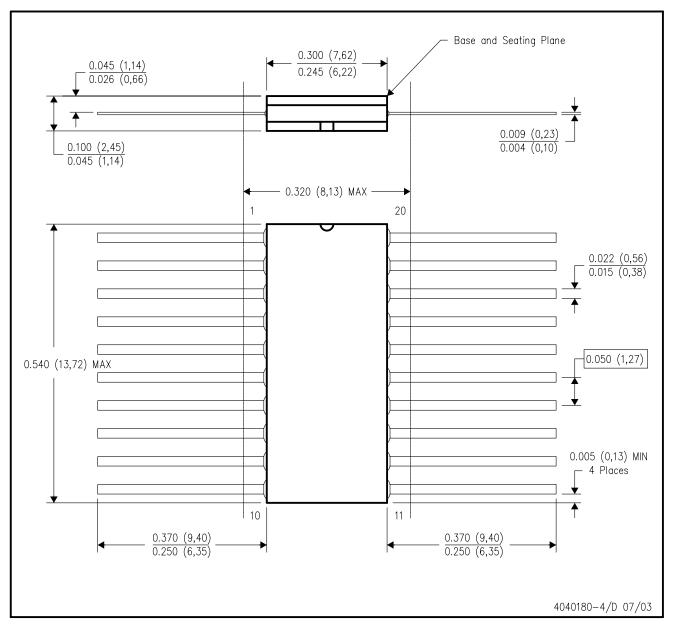


NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

### W (R-GDFP-F20)

### CERAMIC DUAL FLATPACK



NOTES:

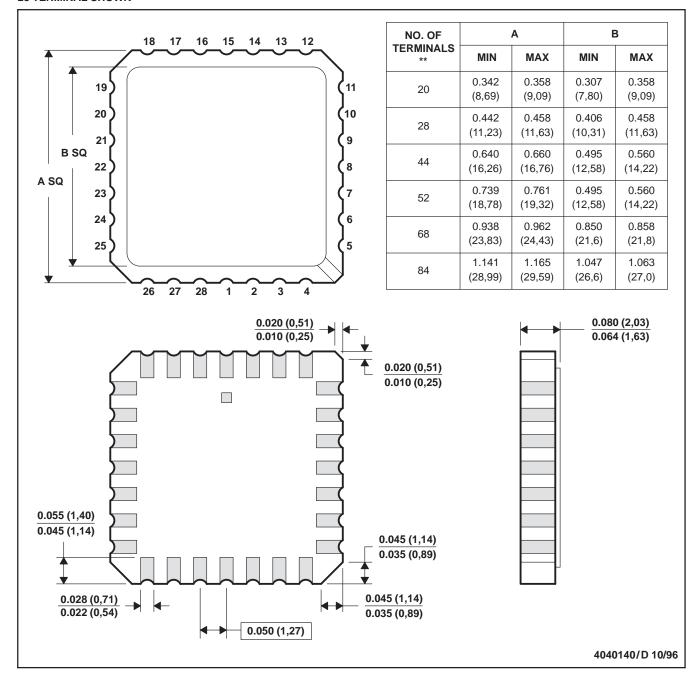
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20



### FK (S-CQCC-N\*\*)

### **28 TERMINAL SHOWN**

### LEADLESS CERAMIC CHIP CARRIER



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004



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